

MOS FIELD EFFECT TRANSISTOR μ PA1911

P-CHANNEL MOS FIELD EFFECT TRANSISTOR FOR SWITCHING

DESCRIPTION

The μ PA1911 is a switching device which can be driven directly by a 2.5-V power source.

The μ PA1911 features a low on-state resistance and excellent switching characteristics, and is suitable for applications such as power switch of portable machine and so on.

FEATURES

- · Can be driven by a 2.5-V power source
- · Low on-state resistance

RDS(on)1 = 115 m Ω MAX. (Vgs = -4.5 V, ID = -1.5 A)

RDS(on)2 = 120 m Ω MAX. (VGS = -4.0 V, ID = -1.5 A)

 $R_{DS(on)3} = 190~m\Omega$ MAX. (Vgs = -2.5 V, ID = -1.0A)

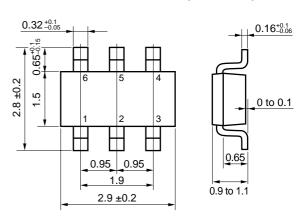
ORDERING INFORMATION

| PART NUMBER | PACKAGE |
|-------------|-----------------------------|
| μPA1911TE | 6-pin Mini Mold (Thin Type) |

ABSOLUTE MAXIMUM RATINGS (TA = 25°C)

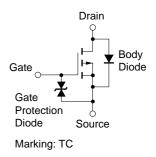
| Drain to Source Voltage | VDSS | -20 | V |
|-------------------------------|--------------------|------------------|----|
| Gate to Source Voltage | Vgss | -12/+6 | V |
| Drain Current (DC) | I _{D(DC)} | + 2.5 | Α |
| Drain Current (pulse) Note1 | ID(pulse) | ∓ 10 | Α |
| Total Power Dissipation | P _{T1} | 0.2 | W |
| Total Power Dissipation Note2 | P _{T2} | 2 | W |
| Channel Temperature | Tch | 150 | °C |
| Storage Temperature | Tstg | -55 to +150 | °C |

PACKAGE DRAWING (Unit: mm)



1, 2, 5, 6 : Drain 3 : Gate 4 : Source

EQUIVALENT CIRCUIT



Notes 1. PW \leq 10 μ s, Duty Cycle \leq 1 %

2. Mounted on FR-4 board, $t \le 5$ sec.

Remark The diode connected between the gate and source of the transistor serves as a protector against ESD. When this device actually used, an additional protection circuit is externally required if a voltage exceeding the rated voltage may be applied to this device.

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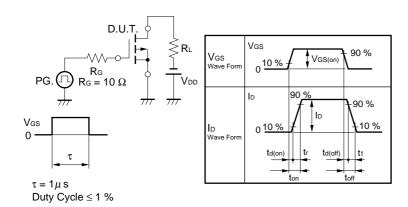
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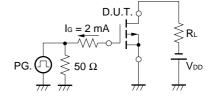
ELECTRICAL CHARACTERISTICS (TA = 25 °C)

| | | · · · · · | | | _ | |
|-------------------------------------|----------------------|--|------|-------|------|------|
| CHARACTERISTICS | SYMBOL | TEST CONDITIONS | MIN. | TYP. | MAX. | UNIT |
| Zero Gate Voltage Drain Current | IDSS | V _{DS} = -20 V, V _{GS} = 0 V | | | -10 | μΑ |
| Gate Leakage Current | Igss | Vgs = ±12 V, Vps = 0 V | | | ±10 | μΑ |
| Gate Cut-off Voltage | V _{GS(off)} | V _{DS} = -10 V, I _D = -1 mA | -0.5 | -0.92 | -1.5 | V |
| Forward Transfer Admittance | y _{fs} | V _{DS} = -10 V, I _D = -1.5 A | 1 | 4.5 | | S |
| Drain to Source On-state Resistance | RDS(on)1 | Vgs = -4.5 V, ID = -1.5 A | | 80 | 115 | mΩ |
| | RDS(on)2 | Vgs = -4.0 V, ID = -1.5 A | | 86 | 120 | mΩ |
| | RDS(on)3 | Vgs = -2.5 V, ID = -1.0 A | | 130 | 190 | mΩ |
| Input Capacitance | Ciss | V _{DS} = -10 V | | 540 | | pF |
| Output Capacitance | Coss | V _G s = 0 V | | 190 | | pF |
| Reverse Transfer Capacitance | Crss | f = 1 MHz | | 90 | | pF |
| Turn-on Delay Time | td(on) | V _{DD} = -10 V | | 140 | | ns |
| Rise Time | tr | I _D = -1.5 A | | 500 | | ns |
| Turn-off Delay Time | td(off) | $V_{GS(on)} = -4.0 \text{ V}$ | | 420 | | ns |
| Fall Time | t _f | $R_G = 10 \Omega$ | | 850 | | ns |
| Total Gate Charge | Q _G | V _{DD} = -10 V | | 5.0 | | nC |
| Gate to Source Charge | Qgs | I _D = -2.5 A | | 1.5 | | nC |
| Gate to Drain Charge | Q _{GD} | Vgs = -4.0 V | | 2.0 | | nC |
| Diode Forward Voltage | V _{F(S-D)} | IF = 2.5 A, VGS = 0 V | | 0.82 | | V |
| Reverse Recovery Time | trr | IF = 2.5 A, Vgs = 0 V | | 30 | | ns |
| Reverse Recovery Charge | Qrr | $di/dt = 10 A/\mu s$ | | 2.0 | | nC |

TEST CIRCUIT 1 SWITCHING TIME

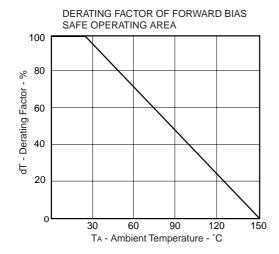


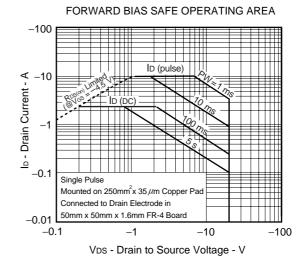
TEST CIRCUIT 2 GATE CHARGE

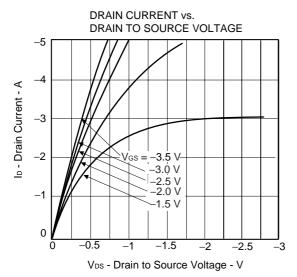


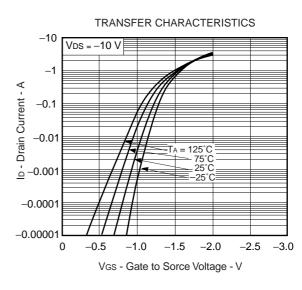


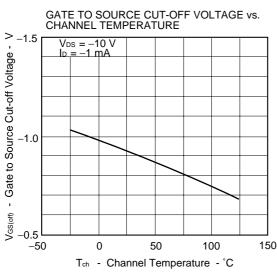
TYPICAL CHARACTERISTICS (TA = 25°C)

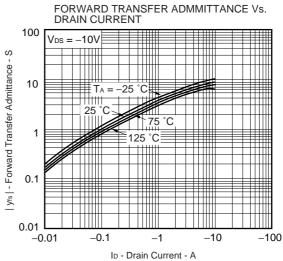




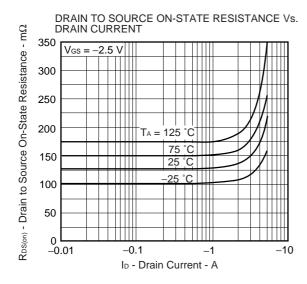


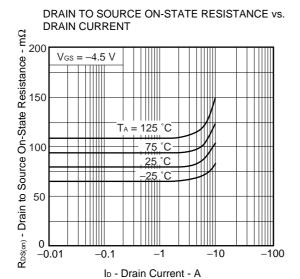


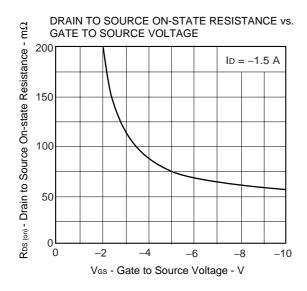


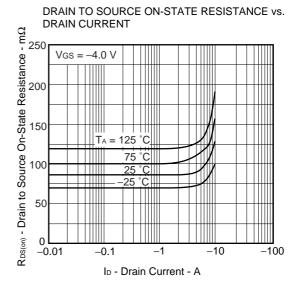


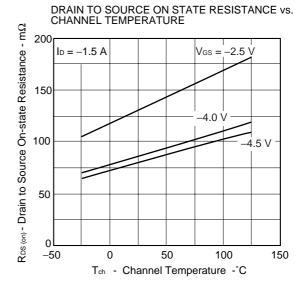
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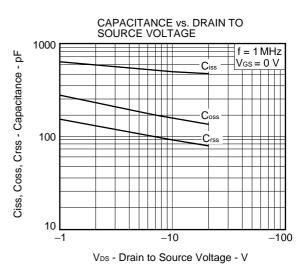


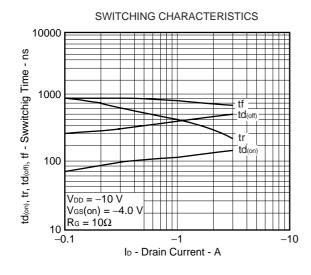




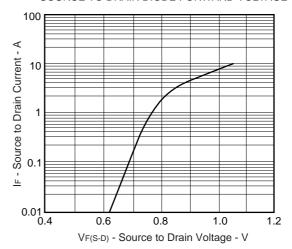


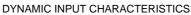


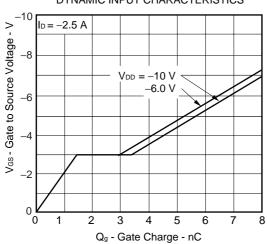




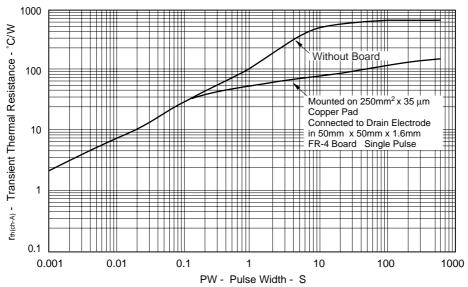
SOURCE TO DRAIN DIODE FORWARD VOLTAGE







TRANSIENT THERMAL RESISTANCE vs. PULSE WIDTH



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NEC

μPA1911

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NEC μ PA1911

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